



RE944-S1

- Solderable Bread Board 28-Pin-Socket
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Hot air leveling (HAL leadfree)
- Solder stop mask
- Adaption circuit board for 28-Pin-Sockets with a distance of 7.62 mm
- Hole spacing 2.54 mm
- 2 x 14 two-hole-pads on each side
- U-shape potential strip
- Size 31.75 x 42,54 mm